

1.5A, 50V - 1000V Glass Passivated Fast Recovery Rectifier

FEATURES

- Glass passivated chip junction
- High current capability, Low V_F
- High reliability
- High surge current capability
- Low power loss, high efficiency
- Compliant to RoHS Directive 2011/65/EU and in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21

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- Switching mode power supply (SMPS)
- Adapters
- TV
- Monitor

MECHANICAL DATA

- Case: DO-204AC (DO-15)
- Molding compound meets UL 94V-0 flammability rating
- Packing code with suffix "G" means green compound (halogen-free)
- Terminal: Pure tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 1A whisker test
- Polarity: As marked
- Weight: 0.4 g (approximately)

KEY PARAMETERS						
PARAMETER	VALUE	UNIT				
I _{F(AV)}	1.5	Α				
V_{RRM}	50 - 1000	V				
I _{FSM}	50 A					
T_{JMAX}	150 °C					
Package	DO-204AC (DO-15)					
Configuration	Single die					





DO-204AC (DO-15)

		FR151	FR152	FR153	FR154	FR155	FR156	FR157	
PARAMETER	SYMBOL	G-T	G-T	G-T	G-T	G-T	G-T	G-T	UNIT
Marking code on the device		FR151G	FR152G	FR153G	FR154G	FR155G	FR156G	FR157G	
Repetitive peak reverse voltage	V_{RRM}	50	100	200	400	600	800	1000	V
Reverse voltage, total rms value	$V_{R(RMS)}$	35	70	140	280	420	560	700	>
Forward current	I _{F(AV)}		1.5			Α			
Surge peak forward current, 8.3 ms single half sine-wave superimposed on rated load per diode	I _{FSM}	50					А		
Junction temperature	T_J	- 55 to +150					°C		
Storage temperature	T _{STG}		- 55 to +150					°C	



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THERMAL PERFORMANCE							
PARAMETER	SYMBOL	LIMIT	UNIT				
Junction-to- ambient thermal resistance	$R_{\Theta JA}$	60	°C/W				

ELECTRICAL SPECIFICATIONS (T _A = 25°C unless otherwise noted)								
PARAMETER	CONDITIONS	SYMBOL	TYP	МАХ	UNIT			
Forward voltage per diode (1)		I _F = 1.5A,T _J = 25°C	V _F	-	1.3	V		
Deverse everent @ reted \/	oor die de (2)	T _J = 25°C		-	5	μA		
Reverse current @ rated V _R	per aloae **	T _J = 125°C	I _R	-	100	μA		
Junction capacitance	Junction capacitance		CJ	20	-	pF		
	FR151G-T	I _F =0.5A , I _R =1.0A I _{RR} =0.25A	t _{rr}	-	150	ns		
	FR152G-T							
	FR153G-T							
Reverse recovery time	FR154G-T							
	FR155G-T			-	250	ns		
	FR156G-T			-	500			
	FR157G-T				300	ns		

Notes:

- 1. Pulse test with PW=0.3 ms
- 2. Pulse test with PW=30 ms

ORDERING INFORMATION							
PART NO.	PACKING CODE	PACKING CODE SUFFIX	PACKAGE	PACKING			
ED45 O T	A0		DO-15	1,500 / Ammo box			
FR15xG-T (Note 1, 2)	R0	G	DO-15	3,500 / 13" Paper reel			
(14010-1, 2)	В0		DO-15	1,000 / Bulk packing			

Notes:

- 1. "x" defines voltage from 50V (FR151G-T) to 1000V (FR157G-T)
- 2. Whole series with green compound (halogen-free)

EXAMPLE P/N							
EXAMPLE P/N	PART NO.	PACKING CODE	PACKING CODE SUFFIX	DESCRIPTION			
FR151G-T A0G	FR151G-T	A0	G	Green compound			



CHARACTERISTICS CURVES

(T_A = 25°C unless otherwise noted)

Fig.1 Forward Current Derating Curve

2 AVERAGE FORWARD CURRENT (A) 1.5 1 0.5 **RESISTIVE OR** INDUCTIVE LOAD 0 25 50 75 100 125 150 AMBIENT TEMPERATURE (°C)

Fig.2 Typical Junction Capacitance

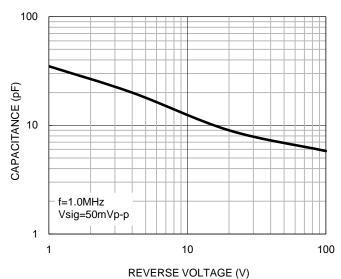


Fig.3 Typical Reverse Characteristics

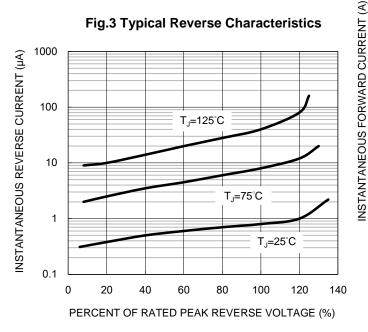
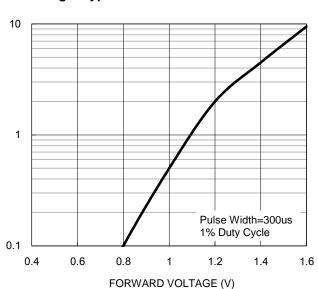


Fig.4 Typical Forward Characteristics





CHARACTERISTICS CURVES

(T_A = 25°C unless otherwise noted)

Fig.5 Maximum Non-repetitive Forward Surge Current

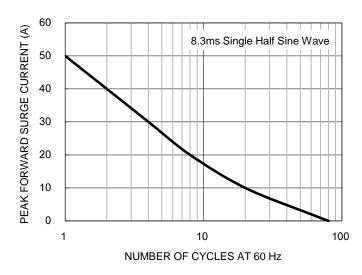
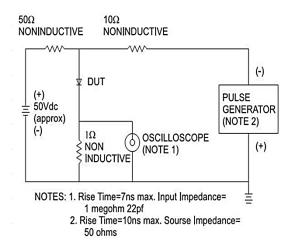
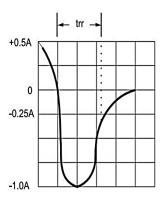


Fig.6 Reverse Recovery Time Characteristic And Test Circuit Diagram

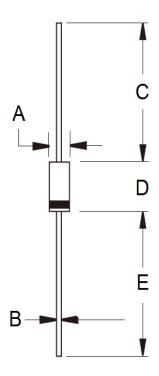






PACKAGE OUTLINE DIMENSIONS

DO-204AC (DO-15)



DIM.	Unit (ı	nm)	Unit (inch)		
DIIVI.	Min	Max	Min	Max	
Α	2.60	3.60	0.102	0.142	
В	0.70	0.90	0.028	0.035	
С	25.40	-	1.000	-	
D	5.80	7.60	0.228	0.299	
E	25.40	1	1.000	-	

MARKING DIAGRAM



P/N = Marking Code
G = Green Compound
YWW = Date Code
F = Factory Code



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